# onsemi

# Dual Buffer with Open Drain Outputs

# NL27WZ07

The NL27WZ07 is a high performance dual buffer with open drain outputs operating from a 1.65 to 5.5 V supply.

#### Features

- Designed for 1.65 V to 5.5 V  $V_{CC}$  Operation
- 2.1 ns  $t_{PD}$  at  $V_{CC} = 5 V (Typ)$
- Inputs/Outputs Overvoltage Tolerant up to 5.5 V
- I<sub>OFF</sub> Supports Partial Power Down Protection
- Sink 24 mA at 3.0 V
- Available in SC-88, SC-74 and UDFN6 Packages
- Chip Complexity < 100 FETs
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

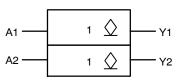
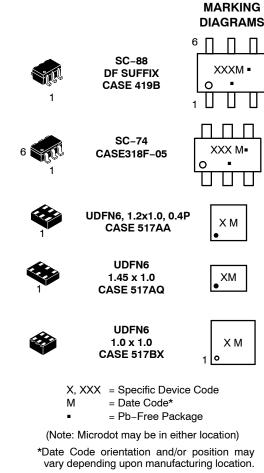
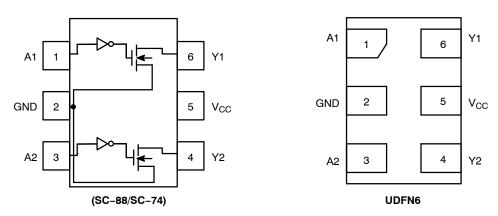


Figure 1. Logic Symbol



## ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 7 of this data sheet.





#### **PIN ASSIGNMENT**

Pin	Function
1	A1
2	GND
3	A2
4	Y2
5	V <sub>CC</sub>
6	Y1

#### FUNCTION TABLE

A Input	Y Output
L	L
Н	Z

#### MAXIMUM RATINGS

Symbol	Characteristics	Value	Unit	
V <sub>CC</sub>	DC Supply Voltage		–0.5 to +6.5	V
V <sub>IN</sub>	DC Input Voltage		–0.5 to +6.5	V
V <sub>OUT</sub>		ctive–Mode (High or Low State) Tri–State Mode (Note 1) Power–Down Mode (V <sub>CC</sub> = 0 V)	-0.5 to V <sub>CC</sub> + 0.5 -0.5 to +6.5 -0.5 to +6.5	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>IN</sub> < GND	-50	mA
I <sub>OK</sub>	DC Output Diode Current	V <sub>OUT</sub> < GND	-50	mA
IOUT	DC Output Source/Sink Current		±50	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC Supply Current per Supply Pin or Ground Pir	ı	±100	mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 secs		260	°C
ТJ	Junction Temperature Under Bias		+150	°C
$\theta_{JA}$	Thermal Resistance (Note 2)	SC-88 SC-74 UDFN6	377 320 154	°C/W
PD	Power Dissipation in Still Air	SC-88 SC-74 UDFN6	332 390 812	mW
MSL	Moisture Sensitivity		Level 1	-
F <sub>R</sub>	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
$V_{\text{ESD}}$	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	2000 1000	V
I <sub>Latchup</sub>	Latchup Performance (Note 4)		±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Applicable to devices with outputs that may be tri-stated.

 Measured with minimum pad spacing on an FR4 board, using 10mm-by-1inch, 2 ounce copper trace no air flow per JESD51-7.
 HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115-A (Machine Model) be discontinued per JEDEC/JEP172A.

4. Tested to EIA/JESD78 Class II.

#### RECOMMENDED OPERATING CONDITIONS

Symbol	Characteristics	Min	Мах	Unit
V <sub>CC</sub>	Positive DC Supply Voltage	1.65	5.5	V
V <sub>IN</sub>	DC Input Voltage	0	5.5	V
V <sub>OUT</sub>	DC Output Voltage Active-Mode (High or Low State) Tri-State Mode (Note 1) Power-Down Mode (V <sub>CC</sub> = 0 V)	0	V <sub>CC</sub> 5.5 5.5	
T <sub>A</sub>	Operating Temperature Range	-55	+125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	0 0	20 20 10 5	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS

			V <sub>cc</sub>	T <sub>A</sub> = 25°C		–55°C ≤ T <sub>A</sub> ≤ 125°C			
Symbol	Parameter	Condition	(V)	Min	Тур	Max	Min	Max	Units
V <sub>IH</sub>	High-Level Input		1.65 to 1.95	0.65 V <sub>CC</sub>	-	_	0.65 V <sub>CC</sub>	-	V
	Voltage		2.3 to 5.5	0.70 V <sub>CC</sub>	-	-	0.70 V <sub>CC</sub>	-	
VIL	Low-Level Input		1.65 to 1.95	-	-	$0.35  V_{CC}$	-	$0.35  V_{CC}$	V
	Voltage		2.3 to 5.5	-	-	0.30 V <sub>CC</sub>	-	0.30 V <sub>CC</sub>	
V <sub>OL</sub>	Low-Level Output Voltage		1.65 to 5.5 1.65 2.3 2.7 3.0 3.0 4.5		0.08 0.2 0.22 0.28 0.38 0.42	0.1 0.24 0.3 0.4 0.4 0.55 0.55	- - - - -	0.1 0.24 0.3 0.4 0.4 0.55 0.55	V
I <sub>IN</sub>	Input Leakage Current	$V_{IN}$ = 5.5 V or GND	1.65 to 5.5	-	-	±0.1	-	±1.0	μA
I <sub>OZ</sub>	3-State Output Leakage Current	$V_{OUT}$ = 0 V to 5.5 V	1.65 to 5.5	-	-	±0.5	-	±5.0	μΑ
I <sub>OFF</sub>	Power Off Leakage Current	V <sub>IN</sub> = 5.5 V or V <sub>OUT</sub> = 5.5 V	0	-	-	1.0	-	10	μΑ
I <sub>CC</sub>	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	5.5	-	-	1.0	_	10	μΑ
ICCT	Quiescent Supply Current	V <sub>IN</sub> = 3.0 V	3.6	-	_	10	-	100	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### AC ELECTRICAL CHARACTERISTICS

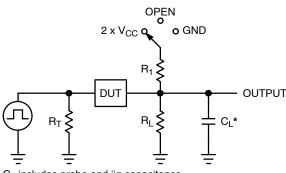
			V <sub>cc</sub>	T,	<sub>Α</sub> = 25°	С	–55°C ≤ T	ע ≤ 125°C	
Symbol	Parameter	Condition	(V)	Min	Тур	Max	Min	Max	Units
t <sub>PZL</sub>	Propagation Delay, A to Y		1.65 to 1.95	-	6.0	9.0	-	9.5	ns
	(Figures 3 and 4)		2.3 to 2.7	-	3.6	6.1	-	6.5	
			3.0 to 3.6	-	2.7	5.6	-	6.0	
			4.5 to 5.5	-	2.1	4.4	-	4.8	
t <sub>PLZ</sub>	Propagation Delay, A to Y		1.65 to 1.95	-	4.0	9.0	-	9.5	ns
	(Figures 3 and 4)		2.3 to 2.7	-	2.8	6.1	-	6.5	
			3.0 to 3.6	-	2.5	5.6	-	6.0	
			4.5 to 5.5		2.2	4.4	_	4.8	

#### **CAPACITIVE CHARACTERISTICS**

Symbol	Parameter	Condition	Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{CC}$ = 5.5 V, $V_{IN}$ = 0 V or $V_{CC}$	2.5	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC}$ = 5.5 V, $V_{IN}$ = 0 V or $V_{CC}$	4.0	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 5)	10 MHz, V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 0 V or V <sub>CC</sub>	4.0	pF

5.  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:  $I_{CC(OPR)} = C_{PD} \bullet V_{CC} \bullet f_{in} + I_{CC}$ .  $C_{PD}$  is used to determine the no–load dynamic power consumption;  $P_D = C_{PD} \bullet V_{CC}^2 \bullet f_{in} + I_{CC} \bullet V_{CC}$ .

Test



	$t_{PLH}$ / $t_{PHL}$	Open	See AC Character	istics Tab	ble
	t <sub>PLZ</sub> / t <sub>PZL</sub>	$2 \times V_{CC}$	50	500	5
TPUT	t <sub>PHZ</sub> / t <sub>PZH</sub>	GND	50	500	5
	X = Don't Car	e			

Switch

Position

 $C_L, pF$ 

 $R_L, \Omega$ 

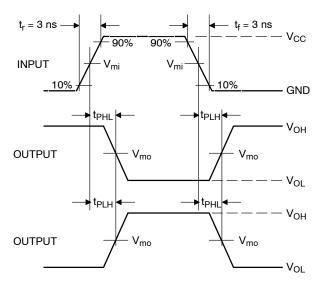
 $R_1, \Omega$ 

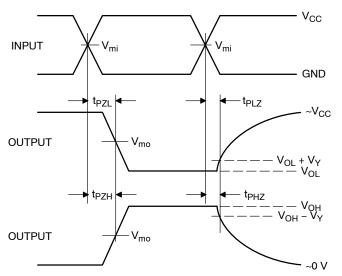
500

500

 $C_L$  includes probe and jig capacitance  $R_T$  is  $Z_{OUT}$  of pulse generator (typically 50  $\Omega)$  f = 1 MHz

## Figure 3. Test Circuit





# Figure 4. Switching Waveforms

		Vm		
V <sub>CC</sub> , V	V <sub>mi</sub> , V	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub> , t <sub>PZH</sub> , t <sub>PHZ</sub>	V <sub>Y</sub> , V
1.65 to 1.95	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	0.15
2.3 to 2.7	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	0.15
3.0 to 3.6	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	0.3
4.5 to 5.5	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	0.3

#### **DEVICE ORDERING INFORMATION**

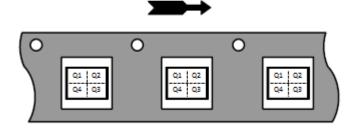
Device	Packages	Specific Device Code	Pin 1 Orientation (See below)	Shipping <sup>†</sup>
NL27WZ07DFT2G	SC-88	M7	Q4	3000 / Tape & Reel
NL27WZ07DFT2G-Q*	SC-88	M7	Q4	3000 / Tape & Reel
NL27WZ07DBVT1G	SC-74	M7	Q4	3000 / Tape & Reel
NL27WZ07MU1TCG (Contact <b>onsemi</b> )	UDFN6, 1.45 x 1.0 x 0.5P	V (Rotated 90° CW)	Q4	3000 / Tape & Reel
NL27WZ07MU2TCG (Contact <b>onsemi</b> )	UDFN6, 1.2 x 1.0 x 0.4P	K (Rotated 180° CW)	Q4	3000 / Tape & Reel
NL27WZ07MU3TCG	UDFN6, 1.0 x 1.0 x 0.35P	A (Rotated 180° CW)	Q4	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
 \*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP

Capable.

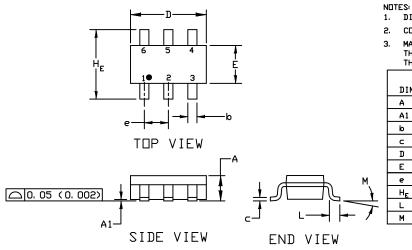
#### **PIN 1 ORIENTATION IN TAPE AND REEL**





#### PACKAGE DIMENSIONS

SC-74 CASE 318F ISSUE P

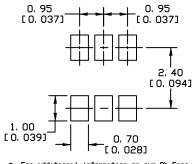


1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994

2. CONTROLLING DIMENSION: INCHES

MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.

	MILLIMETERS			INCHES		
DIM	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.
Α	0. 90	1. 00	1.10	0. 035	0. 039	0. 043
A1	0. 01	0.06	0.10	0. 001	0, 002	0. 004
ø	0. 25	0. 37	0. 50	0. 010	0. 015	0. 020
с	0.10	0.18	0. 26	0. 004	0. 007	0. 010
D	2, 90	3. 00	3.10	0.114	0.118	0. 122
E	1. 30	1. 50	1. 70	0. 051	0. 059	0. 067
e	0.85	0. 95	1. 05	0. 034	0. 037	0. 041
Η <sub>E</sub>	2. 50	2. 75	3. 00	0. 099	0. 108	0.118
L	0. 20	0.40	0. 60	0. 008	0. 016	0. 024
м	0*		10*	0*		10*

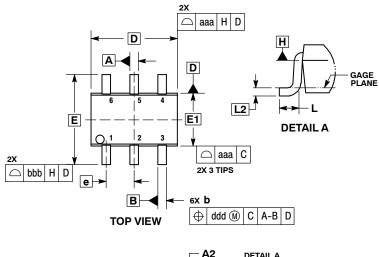


For additional information on our Pb-Free strategy and soldering details, please domload the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SLDERRM/D.

SOLDERING FOOTPRINT

#### PACKAGE DIMENSIONS

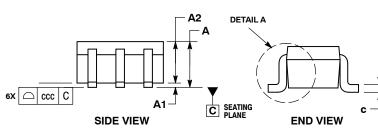
SC-88/SC70-6/SOT-363 CASE 419B-02 **ISSUE Y** 



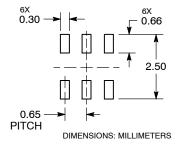
NOTES:

- NOTES:
   DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
   CONTROLLING DIMENSION: MILLIMETERS.
   DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRU-SIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END.
   DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H.
   DATUMS A AND B ARE DETERMINED AT DATUM H.
   DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.
   DIMENSION D 0.05 NOT INCLUDE DAMBAR PROTRUSION
- 7. DIMENSION 6 DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION b AT MAXIMUM MATERIAL CONDI-TION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

DIM         MIN         NOM         MAX         MIN         NOM         MAX           A          1.10          0.043           A1         0.00          0.10         0.000          0.043           A2         0.70         0.90         1.00         0.027         0.035         0.039           b         0.15         0.20         0.25         0.006         0.008         0.019           C         0.08         0.15         0.22         0.070         0.078         0.086           D         1.80         2.00         2.20         0.070         0.078         0.086           E         2.00         2.10         2.20         0.078         0.086         0.086           E         1.15         1.25         1.35         0.045         0.049         0.053           e         0.65         BSC         0.026         0.226         SC            L         0.26         0.36         0.46         0.010         0.014         0.018           L2         0.15         S         0.006         BSC          0.006		MIL	LIMETE	RS	INCHES			
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	DIM	MIN	NOM	MAX	MIN	NOM	MAX	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Α			1.10			0.043	
b         0.15         0.20         0.25         0.006         0.008         0.010           C         0.08         0.15         0.22         0.03         0.006         0.009           D         1.80         2.00         2.20         0.070         0.078         0.086           E         2.00         2.10         2.20         0.078         0.086         E1           I.15         1.25         1.35         0.045         0.049         0.053           e         0.65 BSC         0.026 BSC         0.26 BSC         0.26 BSC         0.006 BSC           L         0.26         0.36 0.46         0.010         0.014         0.018           L2         0.15 BSC         0.006 BSC         0.006 BSC         0.006 BSC	A1	0.00		0.10	0.000		0.004	
C         0.08         0.15         0.22         0.003         0.006         0.009           D         1.80         2.00         2.20         0.070         0.078         0.086           E         2.00         2.10         2.20         0.078         0.082         0.086           E1         1.15         1.25         1.35         0.045         0.049         0.053           e         0.65 BSC         0.026 BSC         0.026 BSC         0.028 BSC         0.018         0.018         0.018           L         0.15 BSC         0.006 BSC         0.006 BSC	A2	0.70	0.90	1.00	0.027	0.035	0.039	
D         1.80         2.00         2.20         0.070         0.078         0.086           E         2.00         2.10         2.20         0.078         0.082         0.086           E1         1.15         1.25         1.35         0.045         0.049         0.053           e         0.65         BSC         0.026         BSC         L         0.26         0.36         0.46         0.010         0.014         0.018           L2         0.15         BSC         0.006         BSC         0.006         BSC	b	0.15	0.20	0.25	0.006	0.008	0.010	
E         2.00         2.10         2.20         0.078         0.082         0.086           E1         1.15         1.25         1.35         0.045         0.049         0.053           e         0.65 BSC         0.026 BSC         0.026 BSC         0.026 BSC         0.026 BSC         0.010         0.014         0.018           L         0.26         0.36 SS         0.46         0.010         0.014         0.018	С	0.08	0.15	0.22	0.003	0.006	0.009	
E1         1.15         1.25         1.35         0.045         0.049         0.053           e         0.65 BSC         0.026 BSC         0.026 BSC           L         0.26         0.36         0.46         0.010         0.014         0.018           L2         0.15 BSC         0.006 BSC         0.006 BSC	D	1.80	2.00	2.20	0.070	0.078	0.086	
e         0.65 BSC         0.026 BSC           L         0.26         0.36         0.46         0.010         0.014         0.018           L2         0.15 BSC         0.006 BSC         0.006 BSC	Е	2.00	2.10	2.20	0.078	0.082	0.086	
L         0.26         0.36         0.46         0.010         0.014         0.018           L2         0.15 BSC         0.006 BSC	E1	1.15 1.25 1.35			0.045	0.049	0.053	
L2 0.15 BSC 0.006 BSC	е	0.65 BSC			0.026 BSC			
	L	0.26	0.36	0.46	0.010	0.014	0.018	
aaa 0.15 0.006	L2	0.15 BSC			0.006 BSC			
	aaa	0.15			0.006			
bbb 0.30 0.012	bbb	0.30			0.012			
ccc 0.10 0.004	ccc	0.10				0.004		
ddd 0.10 0.004	ddd		0.10			0.004		



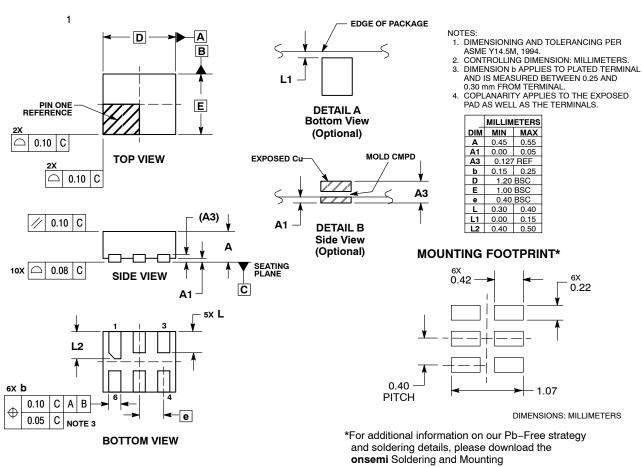
#### RECOMMENDED **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

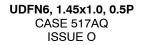
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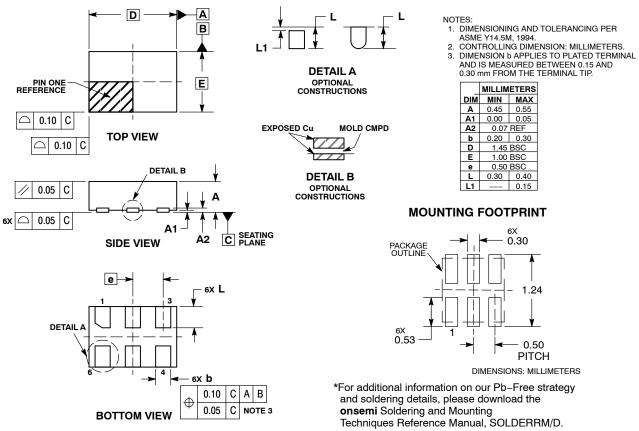
UDFN6, 1.2x1.0, 0.4P CASE 517AA ISSUE D



Techniques Reference Manual, SOLDERRM/D.

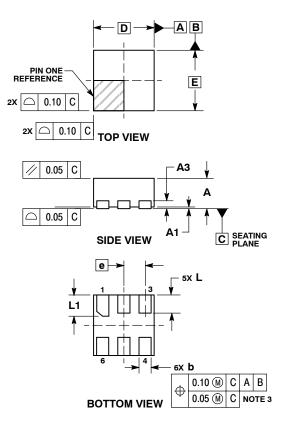
#### PACKAGE DIMENSIONS





#### PACKAGE DIMENSIONS

UDFN6, 1x1, 0.35P CASE 517BX ISSUE O

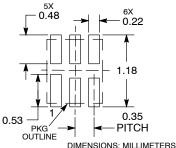


NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS.
   DIMENSION b APPLIES TO PLATED
- TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP. 4. PACKAGE DIMENSIONS EXCLUSIVE OF BURSS AND MOL D EI ASH

BURRS AND MOLD FL		
	MILLIMETERS	
DIM	MIN	MAX
Α	0.45	0.55
A1	0.00	0.05
A3	0.13 REF	
b	0.12	0.22
D	1.00 BSC	
Е	1.00 BSC	
е	0.35 BSC	
L	0.25	0.35
L1	0.30	0.40

#### RECOMMENDED SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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